Francis Gold Sy

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EDUCATION –

City University of New York, City College

Major: B.E., Mechanical Engineering; Minor: Computer Science

GPA: 3.86

Expected Grad: June 2022

S Jay Levy Fellow: a year-long professional development experience culminating in a summer internship

PROFESSIONAL SKILLS -

Software: SolidWorks, Autodesk Fusion 360, MATLAB, Arduino, Java, Python, Microsoft Office Manufacturing: FDM & SLA 3D Printers, Laser Cutter, Prototyping, Design for Manufacturing

EXPERIENCE —

The City College of New York

Oct 2020 - Present

Undergraduate Research Assistant

- Simulating different configurations of an actuated foldable robot using MATLAB Simulink and Gazebo ROS
- Experimenting with Robotics System Toolbox and Simulink to construct and control joints
- Working in a team of two under Dr. Su and Dr. Di Lallo at the Biomechatronics and Intelligent Robotics Lab

WearWorks Inc, NYC

June 2020 – Aug 2020

Mechanical Engineering Intern

- Collaborated in a team of three to design, iterate, and prototype a haptic smartwatch for manufacturing
- Reduced manufacturing costs by integrating design feedback from injection molding companies; conducted plastics and stress simulations in SolidWorks to optimize product for manufacturing
- Managed DFMEA, PFMEA, process flow chart, and other manufacturing-related documents
- Identified and communicated with promising U.S. and overseas suppliers for B.O.M. needs
- Ideated and modeled different versions of packaging for company product

Zahn Innovation Center, CCNY

Feb 2019 - May 2020

Engineering Apprentice

- Using SolidWorks, Fusion 360, 3D printers, and laser cutter for various projects and design applications
- Executed design of various client-requested products through small team collaboration
- Experienced in the use and maintenance of FDM and SLA 3D printers
- Designed, iterated, and delivered a multi-accessory K-8 mathematical learning apparatus to an outside client

WearWorks Inc, NYC

Jan 2020 – Feb 2020

Product Engineering Intern

- Lead development and production of the WayBand for showcasing events and product launch
- Soldered, assembled, and applied finishing techniques for WayBand production
- Operated and maintained the Form 2 to lead product iterations and development

DogSpot Inc, NYC

June 2019 – Aug 2019

Engineering Intern

- Supported circuit board production through wire prep, soldering, and board assembly
- Managed circuit board materials and maintained hardware inventory
- Streamlined circuit board production through documentation of assembly and troubleshooting processes
- Maintained strong communication with assembly team to ensure deadline completion and smooth workflow

PROJECTS —

Customized PCB Keychains

August 2019

- Used Autodesk Fusion 360 to create a two-part keychain casing using a snap-fit mechanism; included company logo on front and font-customized names on the back
- Soldered LEDs, wires, battery mount, and button onto circuit boards; installed boards into 3D printed casing

ACCOMPLISHMENTS –

- March 2019: Mark Zemansky Introductory Physics Prize Winner
- January 2018: FIRST Tech Challenge Inspire Award recipient